

200V Low Charge Injection 8-Channel High Voltage Analog Switch

Features

- ▶ HVCMOS® technology for high performance
- ▶ Very low quiescent power dissipation ($-10\mu\text{A}$)
- ▶ Output on-resistance typically 11Ω
- ▶ Low parasitic capacitance
- ▶ DC to 50MHz small signal frequency response
- ▶ -60dB typical off-isolation at 5.0MHz
- ▶ CMOS logic circuitry for low power
- ▶ Excellent noise immunity
- ▶ Serial shift register logic control with latches
- ▶ Flexible operating supply voltages
- ▶ Surface mount packages

Applications

- ▶ Medical ultrasound imaging
- ▶ Non-destructive evaluation

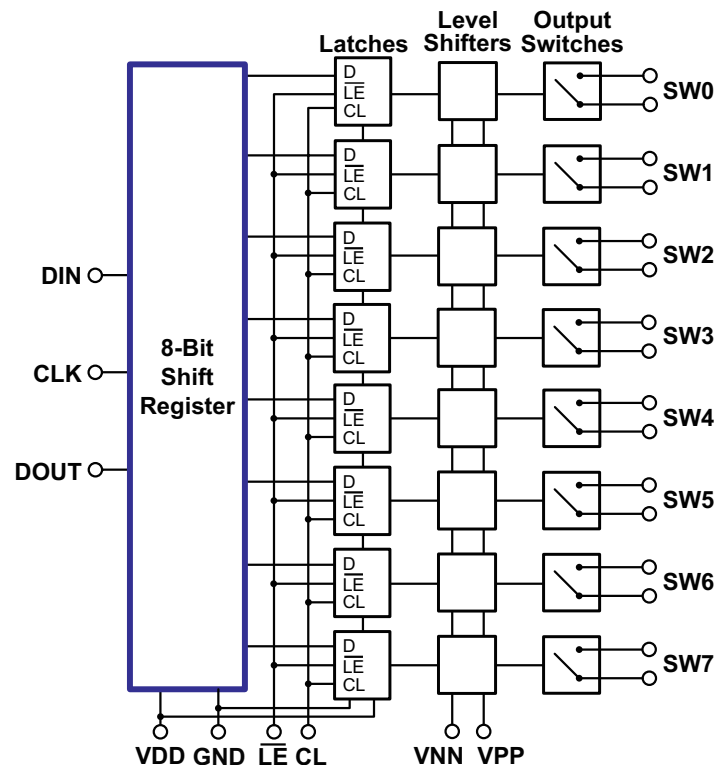
General Description

The Supertex HV219 is a low switch resistance, low charge injection, 8-channel, 200V, analog switch integrated circuit (IC) intended primarily for medical ultrasound imaging. The device can also be used for NDE (non-destructive evaluation) applications. The HV219 is a lower switch resistance, 11Ω versus 22Ω , version of the Supertex HV20220 device. The lower switch resistance will help reduce insertion loss. It has the same pin configuration as that of the Supertex HV20220PJ and the HV20220FG.

The device is manufactured using Supertex's HVCMOS® (high voltage CMOS) technology with high voltage bilateral DMOS structures for the outputs and low voltage CMOS logic for the input control. The outputs are configured as eight independent single pole single throw 11Ω analog switches. The input logic is an 8-bit serial to parallel shift register followed by an 8-bit parallel latch. The switch states are determined by the data in the latch. Logic high will correspond to a closed switch and logic low as an opened switch.

The HV219 is designed to operate on various combinations of high voltage supplies. For example the V_{PP} and V_{NN} supplies can be: $+40\text{V}/-160\text{V}$, $+100\text{V}/-100\text{V}$, or $+160\text{V}/-40\text{V}$. This allows the user to maximize the signal voltage for uni-polar negative, bi-polar, or uni-polar positive.

Block Diagram



Ordering Information

| Part Number | Package Option | Packing |
|----------------|----------------|-----------|
| HV219FG-G | 48-Lead LQFP | 250/Tray |
| HV219FG-G M931 | | 1000/Reel |
| HV219PJ-G | 28-Lead PLCC | 38/Tube |
| HV219PJ-G M904 | | 500/Reel |

-G denotes a lead (Pb)-free / RoHS compliant package

Absolute Maximum Ratings

| Parameter | Value |
|---------------------------------------|--------------------------|
| V_{DD} logic power supply voltage | -0.5V to +15V |
| $V_{PP} - V_{NN}$ supply voltage | 220V |
| V_{PP} positive high voltage supply | -0.5V to $V_{NN} + 200V$ |
| V_{NN} negative high voltage supply | +0.5V to -200V |
| Logic input voltages | -0.5V to $V_{DD} + 0.3V$ |
| Analog signal range | V_{NN} to V_{PP} |
| Peak analog signal current/channel | 3.0A |
| Storage temperature | -65°C to +150°C |
| Power dissipation: 28-Lead PLCC | 1.2W |
| 48-Lead LQFP | 1.0W |

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

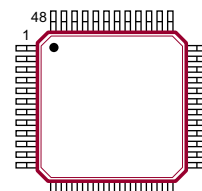
Operating Conditions

| Sym | Parameter | Value |
|-----------|------------------------------------|----------------------------------|
| V_{DD} | Logic power supply voltage | 4.5V to 13.2V |
| V_{PP} | Positive high voltage supply | 40V to $V_{NN} + 200V$ |
| V_{NN} | Negative high voltage supply | -40V to -160V |
| V_{IH} | High level input logic voltage | $V_{DD} - 1.5V$ to V_{DD} |
| V_{IL} | Low-level input logic voltage | 0V to 1.5V |
| V_{SIG} | Analog signal voltage peak-to-peak | $V_{NN} + 10V$ to $V_{PP} - 10V$ |
| T_A | Operating free air temperature | 0°C to 70°C |

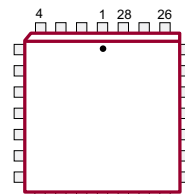
Power Up/Down Sequence

1. Power up/down sequence is arbitrary except GND must be powered up first and powered down last. This applies for applications powering GND of the IC with different voltages.
2. V_{SIG} must always be at or in between V_{PP} and V_{NN} or floating during power up/down transition.
3. Rise and fall times of the power supplies V_{DD} , V_{PP} and V_{NN} should not be less than 1.0ms.

Pin Configuration



48-Lead LQFP
(top view)



28-Lead PLCC
(top view)

Product Marking

Top Marking



YY = Year Sealed
WW = Week Sealed
L = Lot Number
C = Country of Origin*
A = Assembler ID*
— = "Green" Packaging
**May be part of top marking*

Bottom Marking



Package may or may not include the following marks: Si or

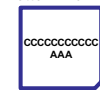
48-Lead LQFP

Top Marking



YY = Year Sealed
WW = Week Sealed
L = Lot Number
C = Country of Origin*
A = Assembler ID*
— = "Green" Packaging
**May be part of top marking*

Bottom Marking



Package may or may not include the following marks: Si or

28-Lead PLCC

Typical Thermal Resistance

| Package | θ_{ja} |
|--------------|---------------|
| 48-Lead LQFP | 52°C/W |
| 28-Lead PLCC | 48°C/W |

DC Electrical Characteristics (over recommended operating conditions unless otherwise noted)

| Sym | Parameter | 0°C | | +25°C | | | +70°C | | Units | Conditions | |
|------------------|--|------|-----|-------|------|-----|-------|-----|----------|---|--|
| | | Min | Max | Min | Typ | Max | Min | Max | | | |
| R_{ONS} | Small signal switch on-resistance | - | 15 | - | 13 | 19 | - | 24 | Ω | $I_{SIG} = 5.0mA$, $V_{PP} = +40V$, $V_{NN} = -160V$ | |
| | | - | 13 | - | 11 | 14 | - | 16 | | $I_{SIG} = 200mA$ | |
| | | - | 13 | - | 11 | 14 | - | 15 | | $I_{SIG} = 5.0mA$, $V_{PP} = +100V$, $V_{NN} = -100V$ | |
| | | - | 9.0 | - | 9.0 | 12 | - | 14 | | $I_{SIG} = 200mA$ | |
| | | - | 12 | - | 10 | 13 | - | 15 | | $I_{SIG} = 5.0mA$, $V_{PP} = +160V$, $V_{NN} = -40V$ | |
| | | - | 11 | - | 8 | 13 | - | 14 | | $I_{SIG} = 200mA$ | |
| ΔR_{ONS} | Small signal switch on-resistance matching | - | 20 | - | 5.0 | 20 | - | 20 | % | $I_{SIG} = 5.0mA$, $V_{PP} = +100V$, $V_{NN} = -100V$ | |
| R_{ONL} | Large signal switch on-resistance | - | - | - | 8.0 | - | - | - | Ω | $V_{SIG} = V_{PP} - 10V$, $I_{SIG} = 1.0A$ | |
| I_{SOL} | Switch off leakage per switch | - | 5.0 | - | 1.0 | 10 | - | 15 | μA | $V_{SIG} = V_{PP} - 10V$ & $V_{NN} + 10V$ | |
| V_{OS} | DC offset switch off | - | 300 | - | 100 | 300 | - | 300 | mV | $R_{LOAD} = 100k\Omega$ | |
| | DC offset switch on | - | 500 | - | 100 | 500 | - | 500 | mV | $R_{LOAD} = 100k\Omega$ | |
| I_{PPQ} | Quiescent V_{PP} supply current | - | - | - | 10 | 50 | - | - | μA | All switches off | |
| I_{NNQ} | Quiescent V_{NN} supply current | - | - | - | -10 | -50 | - | - | μA | All switches off | |
| I_{PPQ} | Quiescent V_{PP} supply current | - | - | - | 10 | 50 | - | - | μA | All switches on, $I_{SW} = 5.0mA$ | |
| I_{NNQ} | Quiescent V_{NN} supply current | - | - | - | -10 | -50 | - | - | μA | All switches on, $I_{SW} = 5.0mA$ | |
| I_{SW} | Switch output peak current | - | 3.0 | - | 3.0 | 2.0 | - | 2.0 | A | V_{SIG} duty cycle < 0.1% | |
| f_{SW} | Output switch frequency | - | - | - | - | 50 | - | - | kHz | Duty cycle = 50% | |
| I_{PP} | Average V_{PP} supply current | - | 6.5 | - | - | 7.0 | - | 8.0 | mA | $V_{PP} = +40V$, $V_{NN} = -160V$ | All output switches are turning on and off at 50kHz with no load |
| | | - | 4.0 | - | - | 5.0 | - | 5.5 | | $V_{PP} = +100V$, $V_{NN} = -100V$ | |
| | | - | 4.0 | - | - | 5.0 | - | 5.5 | | $V_{PP} = +160V$, $V_{NN} = -40V$ | |
| I_{NN} | Average V_{NN} supply current | - | 6.5 | - | - | 7.0 | - | 8.0 | mA | $V_{PP} = +40V$, $V_{NN} = -160V$ | All output switches are turning on and off at 50kHz with no load |
| | | - | 4.0 | - | - | 5.0 | - | 5.5 | | $V_{PP} = +100V$, $V_{NN} = -100V$ | |
| | | - | 4.0 | - | - | 5.0 | - | 5.5 | | $V_{PP} = +160V$, $V_{NN} = -40V$ | |
| I_{DD} | Average V_{DD} supply current | - | 4.0 | - | - | 4.0 | - | 4.0 | mA | $f_{CLK} = 5.0MHz$, $V_{DD} = 5.0V$ | |
| I_{DDQ} | Quiescent V_{DD} supply current | - | 10 | - | - | 10 | - | 10 | μA | All logic inputs are static | |
| I_{SOR} | Data out source current | 0.45 | - | 0.45 | 0.70 | - | 0.40 | - | mA | $V_{OUT} = V_{DD} - 0.7V$ | |
| I_{SINK} | Data out sink current | 0.45 | - | 0.45 | 0.70 | - | 0.40 | - | mA | $V_{OUT} = 0.7V$ | |
| C_{IN} | Large input capacitance | - | 10 | - | - | 10 | - | 10 | pF | --- | |

AC Electrical Characteristics (over recommended operating conditions, $V_{DD} = 5.0V$, unless otherwise noted)

| Sym | Parameter | 0°C | | +25°C | | | +70°C | | Units | Conditions |
|---------------|--|-----|-----|-------|------|-----|-------|-----|---------|---|
| | | Min | Max | Min | Typ | Max | Min | Max | | |
| t_{SD} | Set-up time before \overline{LE} rises | 150 | - | 150 | - | - | 150 | - | ns | --- |
| t_{WLE} | Time width of \overline{LE} | 150 | - | 150 | - | - | 150 | - | ns | --- |
| t_{DO} | Clock delay time to data out | - | 150 | - | - | 150 | - | 150 | ns | --- |
| t_{WCL} | Time width of CL | 150 | - | 150 | - | - | 150 | - | ns | --- |
| t_{SU} | Set-up time data to clock | 15 | - | 15 | 8.0 | - | 20 | - | ns | --- |
| t_H | Hold time data from clock | 35 | - | 35 | - | - | 35 | - | ns | --- |
| f_{CLK} | Clock frequency | - | 5.0 | - | - | 5.0 | - | 5.0 | MHz | 50% duty cycle, $f_{DATA} = f_{CLK}/2$ |
| t_r, t_f | Clock rise and fall times | - | 50 | - | - | 50 | - | 50 | ns | --- |
| T_{ON} | Turn-on time | - | 5.0 | - | - | 5.0 | - | 5.0 | μs | $V_{SIG} = V_{PP} - 10V$, $R_{LOAD} = 10k\Omega$ |
| T_{OFF} | Turn-off time | - | 5.0 | - | - | 5.0 | - | 5.0 | μs | |
| dv/dt | Maximum V_{SIG} slew rate | - | 20 | - | - | 20 | - | 20 | V/ns | $V_{PP} = +40V, V_{NN} = -160V$ |
| | | - | 20 | - | - | 20 | - | 20 | | $V_{PP} = +100V, V_{NN} = -100V$ |
| | | - | 20 | - | - | 20 | - | 20 | | $V_{PP} = +160V, V_{NN} = -40V$ |
| K_O | Off isolation | -30 | - | -30 | -33 | - | - | - | dB | $f = 5.0MHz$, 1.0K Ω //15pF load |
| | | -58 | - | -58 | - | - | - | - | | $f = 5.0MHz, 50\Omega$ load |
| K_{CR} | Switch crosstalk | - | - | -60 | - | - | - | - | dB | $f = 5.0MHz, 50\Omega$ load |
| I_{ID} | Output switch isolation diode current | - | 300 | - | - | 300 | - | 300 | mA | 300ns pulse width, 2% duty cycle |
| $C_{SG(OFF)}$ | Off capacitance SW to GND | 14 | 25 | 14 | 20 | 25 | 14 | 25 | pF | 0V, $f = 1.0MHz$ |
| $C_{SG(ON)}$ | On capacitance SW to GND | 40 | 60 | 40 | 50 | 60 | 40 | 60 | pF | 0V, $f = 1.0MHz$ |
| $+V_{SPK}$ | Output voltage spike | - | - | - | - | 150 | - | - | mV | $V_{PP} = +40V$, $V_{NN} = -160V, R_{LOAD} = 50\Omega$ |
| $-V_{SPK}$ | | - | - | - | - | 200 | - | - | | |
| $+V_{SPK}$ | | - | - | - | - | 150 | - | - | | $V_{PP} = +100V$, $V_{NN} = -100V, R_{LOAD} = 50\Omega$ |
| $-V_{SPK}$ | | - | - | - | - | 200 | - | - | | |
| $+V_{SPK}$ | | - | - | - | - | 150 | - | - | | $V_{PP} = +160V$, $V_{NN} = -40V, R_{LOAD} = 50\Omega$ |
| $-V_{SPK}$ | | - | - | - | - | 200 | - | - | | |
| QC | Charge injection | - | - | - | 1450 | - | - | - | pC | $V_{PP} = +40V$, $V_{NN} = -160V, V_{SIG} = 0V$ |
| | | - | - | - | 1050 | - | - | - | | $V_{PP} = +100V$, $V_{NN} = -100V, V_{SIG} = 0V$ |
| | | - | - | - | 550 | - | - | - | | $V_{PP} = +160V$, $V_{NN} = -40V, V_{SIG} = 0V$ |

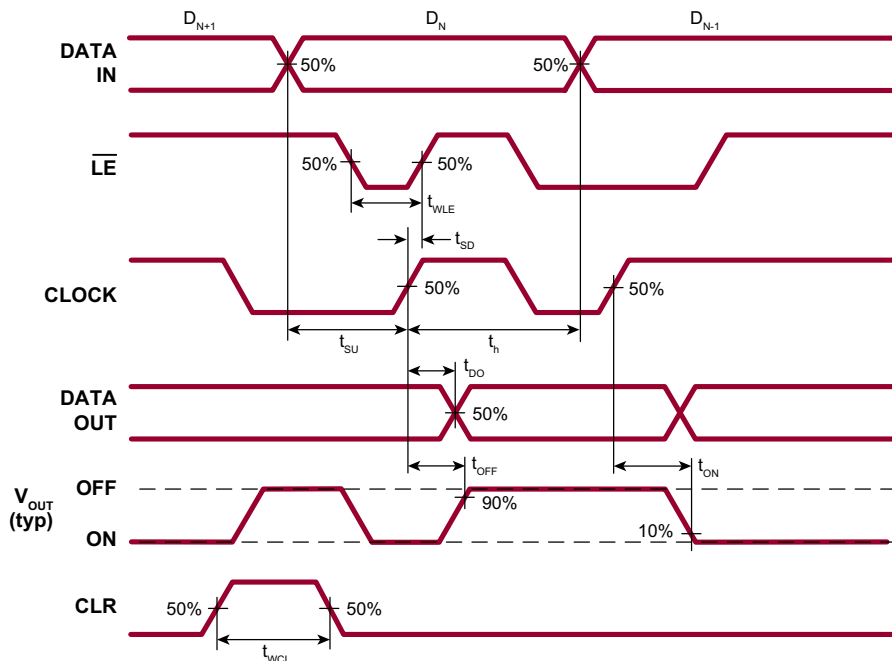
Truth Table

| Data in 8-Bit Shift Register | | | | | | | | \overline{LE} | CL | Output Switch State | | | | | | | |
|------------------------------|----|----|----|----|----|----|----|-----------------|----|---------------------|-----|-----|-----|-----|-----|-----|-----|
| D0 | D1 | D2 | D3 | D4 | D5 | D6 | D7 | | | SW0 | SW1 | SW2 | SW3 | SW4 | SW5 | SW6 | SW7 |
| L | | | | | | | | L | L | OFF | | | | | | | |
| H | | | | | | | | L | L | ON | | | | | | | |
| | L | | | | | | | L | L | | OFF | | | | | | |
| | H | | | | | | | L | L | | ON | | | | | | |
| | | L | | | | | | L | L | | | OFF | | | | | |
| | | H | | | | | | L | L | | | ON | | | | | |
| | | | L | | | | | L | L | | | | OFF | | | | |
| | | | H | | | | | L | L | | | | ON | | | | |
| | | | | L | | | | L | L | | | | | OFF | | | |
| | | | | H | | | | L | L | | | | | ON | | | |
| | | | | | L | | | L | L | | | | | | OFF | | |
| | | | | | H | | | L | L | | | | | | ON | | |
| | | | | | | L | | L | L | | | | | | | OFF | |
| | | | | | | H | | L | L | | | | | | | ON | |
| X | X | X | X | X | X | X | X | H | L | Hold Previous State | | | | | | | |
| X | X | X | X | X | X | X | X | X | H | OFF | OFF | OFF | OFF | OFF | OFF | OFF | OFF |

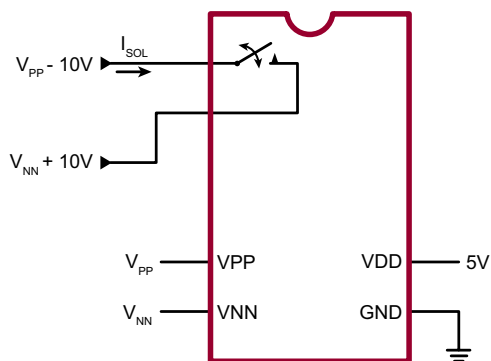
Notes:

1. The eight switches operate independently.
2. Serial data is clocked in on the L to H transition clock.
3. The switches go to a state retaining their present condition at the rising edge of the \overline{LE} .
4. When \overline{LE} is low, the shift register data flows through the latch.
5. Shift register clocking has no effect on the switch states if \overline{LE} is high.
6. The clear input overrides all other inputs.

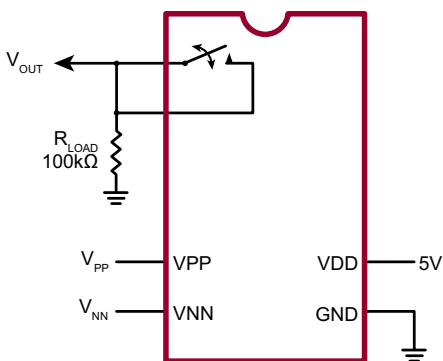
Logic Timing Waveforms



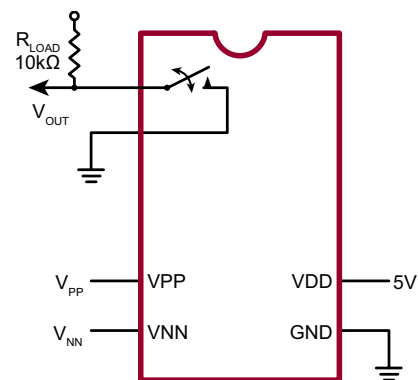
Test Circuits



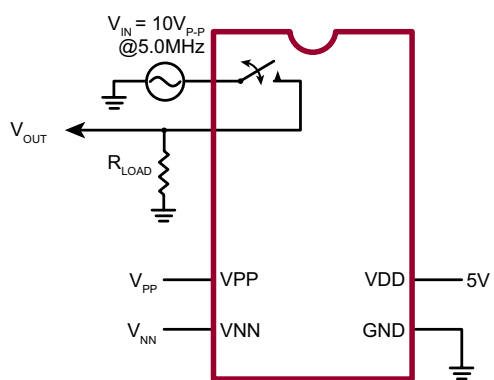
Switch OFF Leakage



DC Offset ON/OFF

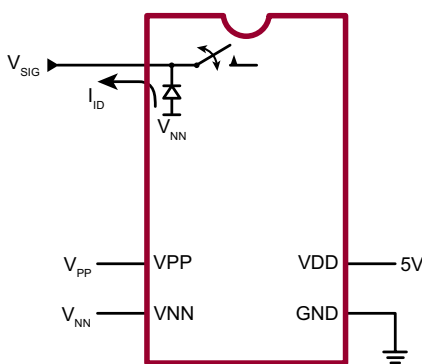


T_{ON}/T_{OFF} Test Circuit

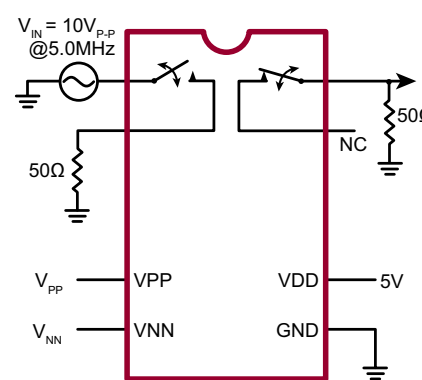


$$K_o = 20 \text{ Log} \frac{V_{OUT}}{V_{IN}}$$

OFF Isolation

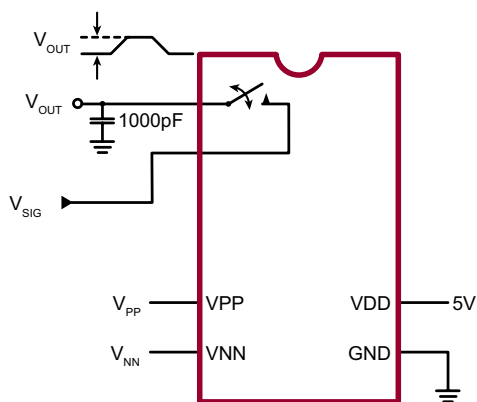


Isolation Diode Current



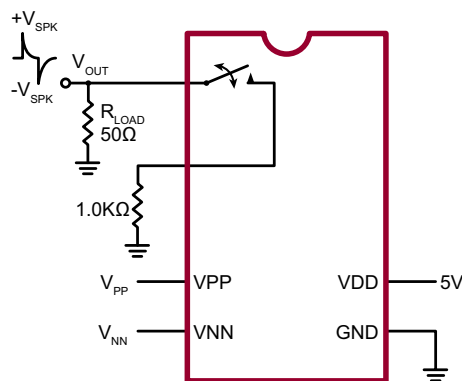
$$K_{CR} = 20 \text{ Log} \frac{V_{OUT}}{V_{IN}}$$

Crosstalk



$$Q = 1000\text{pF} \times V_{OUT}$$

Charge Injection



Output Voltage Spike

Pin Description 48-Lead LQFP

| Pin | Name |
|-----|------|
| 1 | SW5 |
| 2 | NC |
| 3 | SW4 |
| 4 | NC |
| 5 | SW4 |
| 6 | NC |
| 7 | NC |
| 8 | SW3 |
| 9 | NC |
| 10 | SW3 |
| 11 | NC |
| 12 | SW2 |

| Pin | Name |
|-----|------|
| 13 | NC |
| 14 | SW2 |
| 15 | NC |
| 16 | SW1 |
| 17 | NC |
| 18 | SW1 |
| 19 | NC |
| 20 | SW0 |
| 21 | NC |
| 22 | SW0 |
| 23 | NC |
| 24 | VPP |

| Pin | Name |
|-----|-----------------|
| 25 | VNN |
| 26 | NC |
| 27 | NC |
| 28 | GND |
| 29 | VDD |
| 30 | NC |
| 31 | NC |
| 32 | NC |
| 33 | DIN |
| 34 | CLK |
| 35 | \overline{LE} |
| 36 | CLR |

| Pin | Name |
|-----|------|
| 37 | DOUT |
| 38 | NC |
| 39 | SW7 |
| 40 | NC |
| 41 | SW7 |
| 42 | NC |
| 43 | SW6 |
| 44 | NC |
| 45 | SW6 |
| 46 | NC |
| 47 | SW5 |
| 48 | NC |

Pin Description 28-Lead PLCC

| Pin | Name |
|-----|------|
| 1 | SW3 |
| 2 | SW3 |
| 3 | SW2 |
| 4 | SW2 |
| 5 | SW1 |
| 6 | SW1 |
| 7 | SW0 |

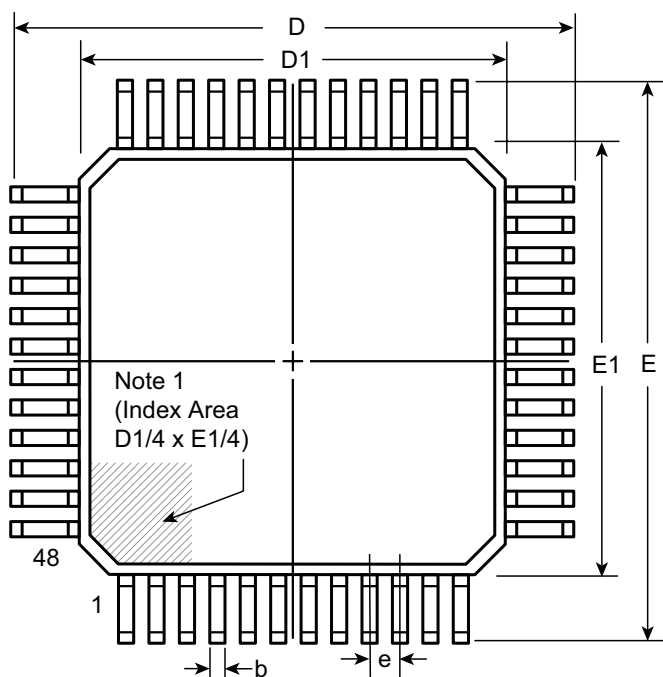
| Pin | Name |
|-----|------|
| 8 | SW0 |
| 9 | NC |
| 10 | VPP |
| 11 | NC |
| 12 | VNN |
| 13 | GND |
| 14 | VDD |

| Pin | Name |
|-----|-----------------|
| 15 | NC |
| 16 | DIN |
| 17 | CLK |
| 18 | \overline{LE} |
| 19 | CL |
| 20 | DOUT |
| 21 | SW7 |

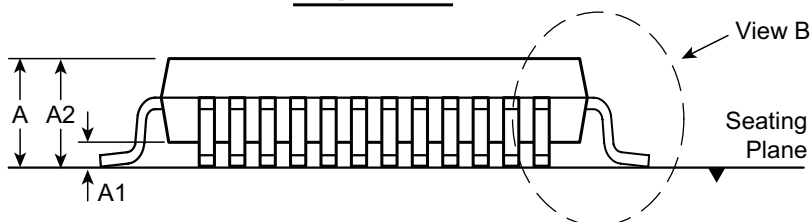
| Pin | Name |
|-----|------|
| 22 | SW7 |
| 23 | SW6 |
| 24 | SW6 |
| 25 | SW5 |
| 26 | SW5 |
| 27 | SW4 |
| 28 | SW4 |

48-Lead LQFP Package Outline (FG)

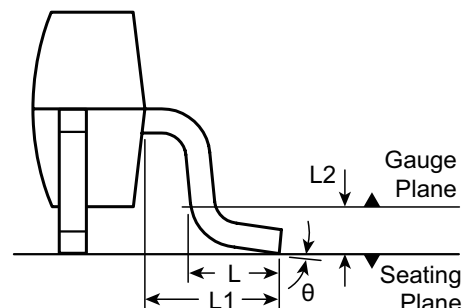
7.00x7.00mm body, 1.60mm height (max), 0.50mm pitch



Top View



Side View



View B

Note:
 1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

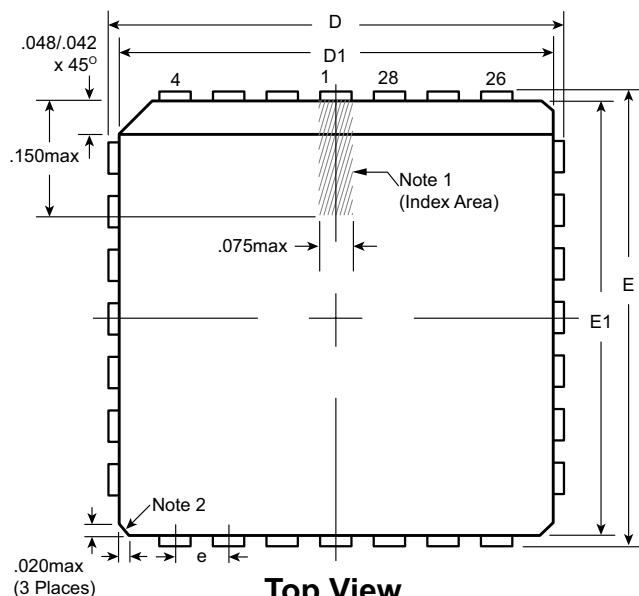
| Symbol | A | A1 | A2 | b | D | D1 | E | E1 | e | L | L1 | L2 | θ | |
|----------------|-----|-------|------|------|------|-------|-------|-------|-------|----------|------|----------|----------|------|
| Dimension (mm) | MIN | 1.40* | 0.05 | 1.35 | 0.17 | 8.80* | 6.80* | 8.80* | 6.80* | 0.50 BSC | 0.45 | 1.00 REF | 0.25 BSC | 0° |
| | NOM | - | - | 1.40 | 0.22 | 9.00 | 7.00 | 9.00 | 7.00 | | 0.60 | | | 3.5° |
| | MAX | 1.60 | 0.15 | 1.45 | 0.27 | 9.20* | 7.20* | 9.20* | 7.20* | | 0.75 | | | 7° |

JEDEC Registration MS-026, Variation BBC, Issue D, Jan. 2001.
 * This dimension is not specified in the JEDEC drawing.

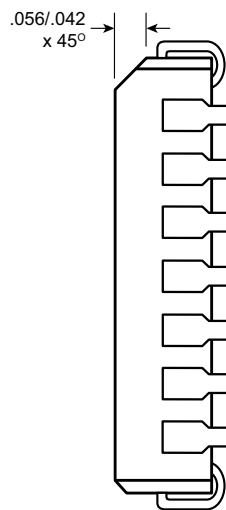
Drawings are not to scale.
 Supertex Doc. #: DSPD-48LQFPFG Version, D041309.

28-Lead PLCC Package Outline (PJ)

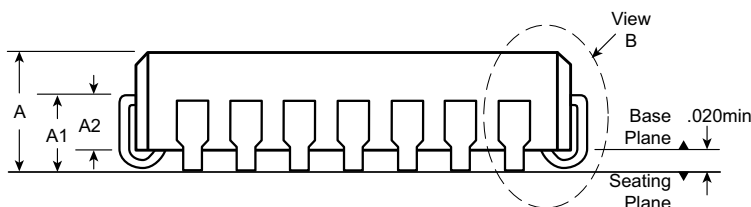
.453x.453in. body, .180in. height (max), .050in. pitch



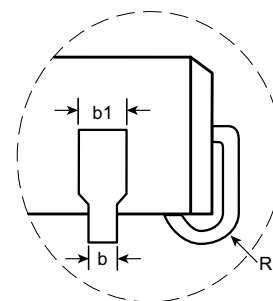
Top View



Vertical Side View



Horizontal Side View



View B

Notes:

1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.
2. Actual shape of this feature may vary.

| Symbol | | A | A1 | A2 | b | b1 | D | D1 | E | E1 | e | R |
|--------------------|-----|------|------|------|------|------|------|------|------|------|-------------|------|
| Dimension (inches) | MIN | .165 | .090 | .062 | .013 | .026 | .485 | .450 | .485 | .450 | .050 BSC | .025 |
| | NOM | .172 | .105 | - | - | - | .490 | .453 | .490 | .453 | | .035 |
| | MAX | .180 | .120 | .083 | .021 | .032 | .495 | .456 | .495 | .456 | | .045 |

JEDEC Registration MS-018, Variation AB, Issue A, June, 1993.

Drawings not to scale.

Supertex Doc. #: DSPD-28PLCCPJ, Version B031111.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <http://www.supertex.com/packaging.html>.)

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- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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